

N-Channel Super Junction Power MOSFET $\,\,{\rm IV}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features

- Optimized body diode reverse recovery performance
- •Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ●ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

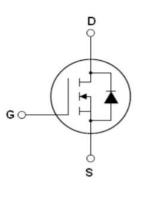
Package Marking And Ordering Information

Device	Device Package	Marking
NCE65N1K2K	TO-252	NCE65N1K2K

Table 1. Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGs=0V)	Vds	650	V
Gate-Source Voltage (V _{DS} =0V) ,AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (VDs=0V) ,DC	Vgs	±20	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	3.8	A
Continuous Drain Current at Tc=100°C	I _{D (DC)}	2.66	A
Pulsed drain current ^(Note 1)	DM (pluse)	11.4	A
Maximum Power Dissipation(Tc=25°C)	PD	46	W
Derate above 25°C		0.3	W/°C
Single pulse avalanche current (Note 2)	I _{AS}	1	A
Reverse diode dv/dt, $V_{DS} \leqslant 480 \text{ V},I_{SD} < I_D$	dv/dt	15	V/ns
Drain Source voltage slope, $V_{DS} \leqslant 480 V$	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	TJ,TSTG	-55+175	°C

V _{DS min@Tjmax}	710	V
Rds(on)typ.	1050	mΩ
ID	3.8	А
Qg	10	nC



Schematic diagram

G D S



Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	3.26	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	OI Condition Min		Min Typ	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250uA	V _{GS} =0V I _D =250uA 650			V
Zero Gate Voltage Drain Current(Tc=25°C)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125°C)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			50	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, I _D =250uA	3		4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I _D =1.9A		1050	1200	mΩ
Dynamic Characteristics						
Gate Resistance	Rg	F=1MHZ, D-S short		34		Ω
Input Capacitance	Clss			316		pF
Output Capacitance	Coss	V _{DS} =50V,V _{GS} =0V,		12		pF
Reverse Transfer Capacitance	Crss	F=1MHz		5		pF
Total Gate Charge	Qg			10	12	nC
Gate-Source Charge	Q _{gs}	V _{DS} =480V,I _D =2A, V _{GS} =10V		1.1		nC
Gate-Drain Charge	Q _{gd}			7.5		nC
Gate plateau voltage	Vgp			5.3		V
Switching times						
Turn-on Delay Time	t _{d(on)}			8		nS
Turn-on Rise Time	tr	V _{DD} =480V,I _D =2A, R _G =4Ω,V _{GS} =10V		10		nS
Turn-Off Delay Time	t _{d(off)}			41		nS
Turn-Off Fall Time	tf			9		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	того			3.8	А
Pulsed-Source-drain current(Body Diode)	I _{SDM}	Tc=25°C			11.4	А
Forward on voltage	V _{SD}	Tj=25°C,I _{SD} =3.8A,V _{GS} =0V		1.0	1.2	V
Reverse Recovery Time	t _{rr}	T : 0500 k as		185		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I⊧2A,		0.55		uC
Peak reverse recovery current	Irrm	di/dt=100A/µs		6		А

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25 $^\circ C$,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

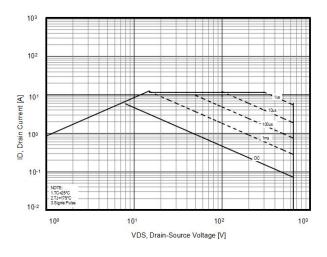


Figure3. Output characteristics

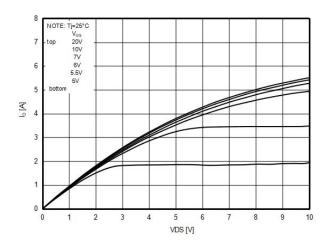


Figure5. Static drain-source on resistance

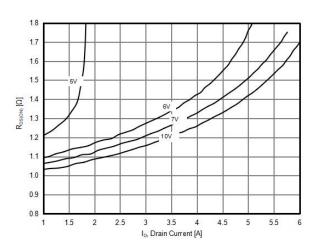


Figure2. Source-Drain Diode Forward Voltage

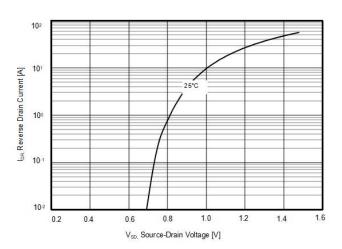


Figure4. Transfer characteristics

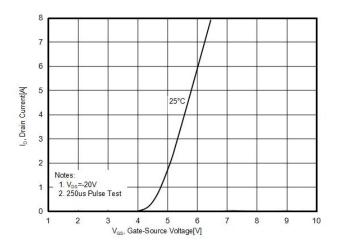


Figure6. RDS(ON) vs Junction Temperature

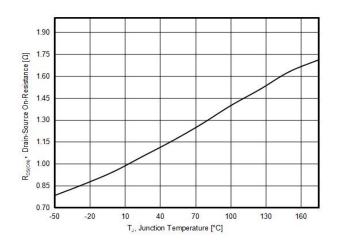




Figure7. BV_{DSS} vs Junction Temperature

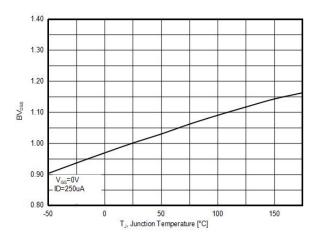


Figure9. Gate charge waveforms

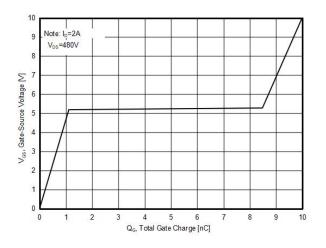


Figure8. Maximum I_D vs Junction Temperature

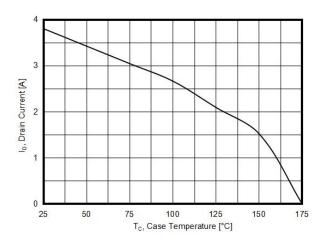
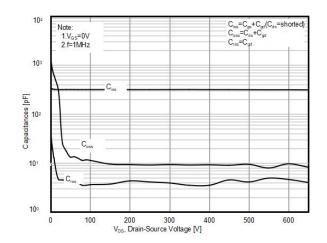


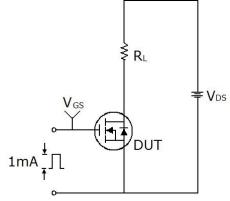
Figure10. Capacitance

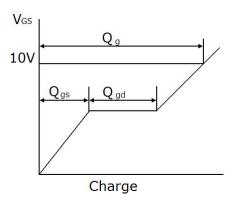




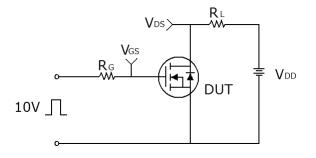
Test circuit

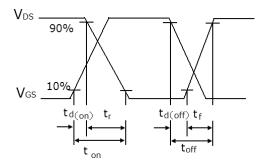
1) Gate charge test circuit & Waveform



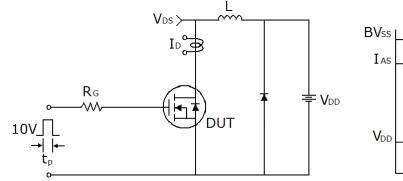


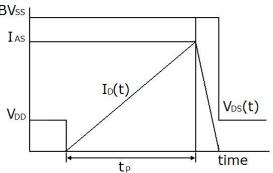
2) Switch Time Test Circuit:





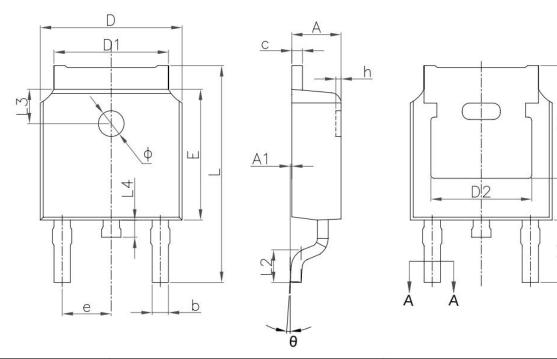
3) Unclamped Inductive Switching Test Circuit & Waveforms







TO-252-E Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
	Min.	Max.	Min.	Max.		
А	2.20	2.40	0.087	0.094		
A1	0.00	0.13	0.000	0.005		
b	0.66	0.86	0.026	0.033		
b1	0.73	0.79	0.029	0.031		
С	0.46	0.58	0.018	0.023		
c1	0.50	0.52	0.020	0.020		
D	6.50	6.70	0.256	0.264		
D1	5.10	5.46	0.201	0.215		
D2	4.83	4.83 REF		0.19REF		
E	6.00	6.20	0.236	0.244		
е	2.19	2.39	0.086	0.094		
L	9.80	10.40	0.386	0.409		
L1	2.90 REF		0.11REF			
L2	1.40	1.70	0.055			
L3	1.60 REF		0.06REF			
L4	0.60	1.00	0.024	0.039		
Φ	1.10	1.30	0.043	0.051		
θ	0°	8°	0°	8°		
h	0.00	0.30	0.000	0.012		



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